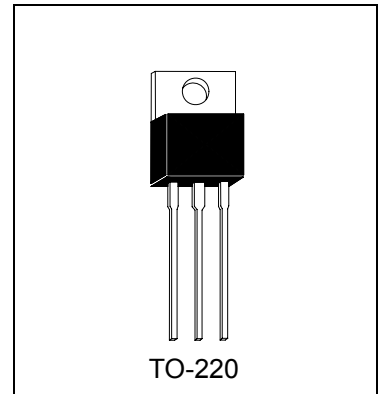


3-TERMINAL NEGATIVE VOLTAGE REGULATOR

LM7912E3

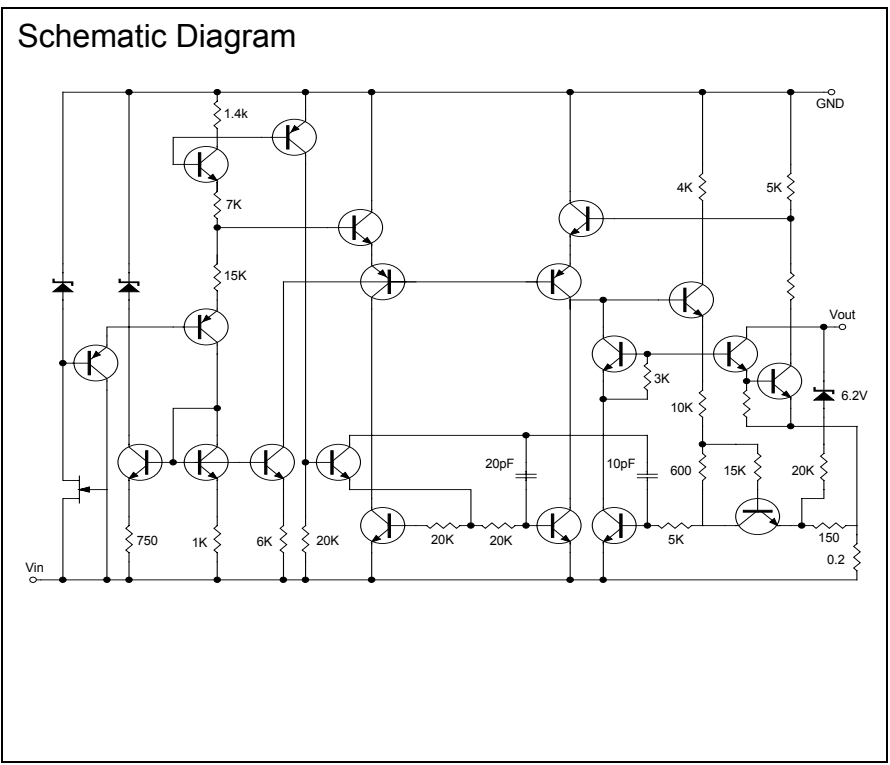
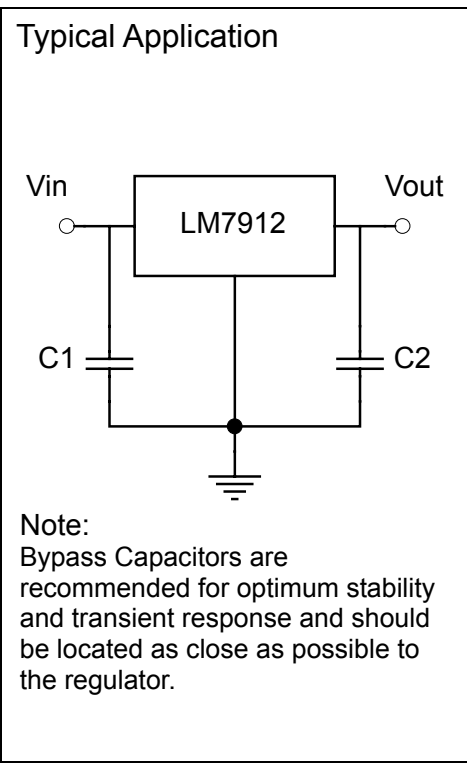


Description

The LM7912E3 series of three-terminal negative regulators are available in the TO-220 package. These regulators can provide local on-card regulation, eliminating the distribution problems associated with single point regulation. Each employs internal current limiting, thermal shutdown and safe operating area protection, making it essentially indestructible. If adequate heat sinking is provided, they can deliver over 1.5A output current. Although designed primarily as fixed voltage regulators, these devices can be used with external components to obtain adjustable voltages and currents. LM7912E3 is characterized for operation from -40°C to +125°C, and if operating temperature is always high, please refer to the power dissipation curve.

Absolute Maximum Ratings (Ta=25°C)

- Input Voltage -35 V
- Total Power Dissipation Internally limited
- Operating Junction Temperature -40 °C to +125 °C
- Maximum Junction Temperature 125 °C
- Storage Temperature Range -65 °C to +150 °C
- Lead Temperature (Soldering 10S) 230 °C





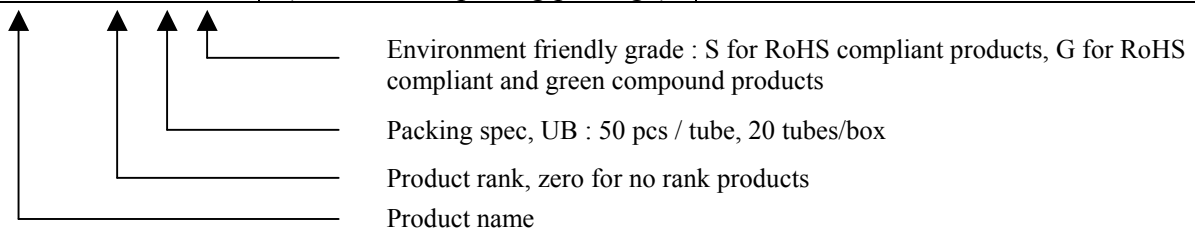
Electrical Characteristics

$V_{in} = -19V$, $I_o = 500mA$, $C_{in} = 2.2\mu F$, $C_{out} = 1\mu F$, $0^\circ C \leq T_j \leq 125^\circ C$ (unless otherwise noted)

Symbol	Parameter	Conditions	Limits			Units
			Min	Typ	Max	
Vo	Output Voltage	$T_j = 25^\circ C$	-11.4	-12	-12.6	V
	Output Voltage	$P_D \leq 15W$, $5mA \leq I_o \leq 1A$ $-15.5V \geq V_{in} \geq -27V$	-11.4	-12	-12.6	
ΔV_o	Line Regulation	$T_j = 25^\circ C$, $-14.5V \geq V_{in} \geq -30V$	-	-	240	mV
		$T_j = 25^\circ C$, $-16V \geq V_{in} \geq -22V$	-	-	120	
ΔV_o	Load Regulation	$5mA \leq I_o \leq 1.5A$	-	-	240	mV
		$250mA \leq I_o \leq 750mA$	-	-	120	
IQ	Quiescent Current	$I_o \leq 1A$, $T_j = 25^\circ C$	-	3	8	mA
ΔIQ	Quiescent Current Change	$5mA \leq I_o \leq 1A$	-	-	0.5	mA
		$-14.5V \geq V_{in} \geq -30V$	-	-	1.0	
$\Delta V_o / \Delta T$	Output Voltage Drift	$I_o = 5mA$	-	-0.8	-	mV/ $^\circ C$
Vn	Output Noise Voltage	$T_a = 25^\circ C$, $10Hz \leq f \leq 100KHz$	-	200	-	μV
RR	Ripple Rejection	$\Delta V_i = 10V$, $f = 120Hz$	54	68	-	dB
VD	Dropout Voltage	$T_j = 25^\circ C$, $I_o = 1A$	-	2	-	V
Isc	Short Circuit Current	$T_j = 25^\circ C$, $V_{in} = -35V$	-	2.2	-	A
Ipk	Peak Output Current	$T_j = 25^\circ C$	1.3	2.2	-	A

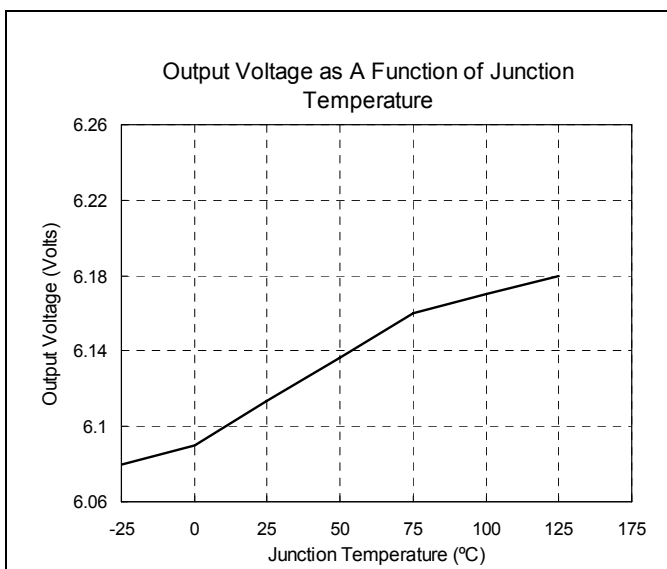
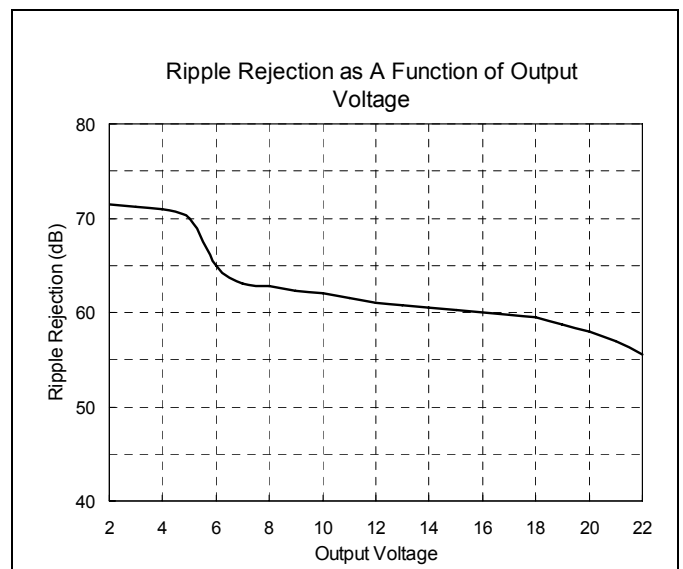
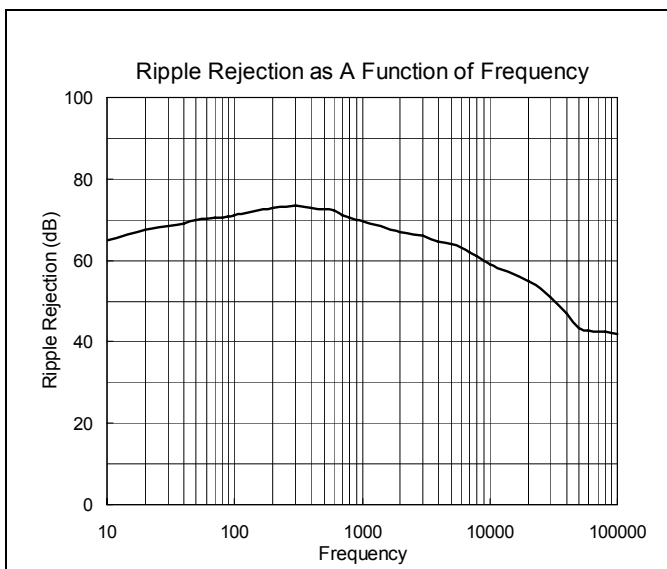
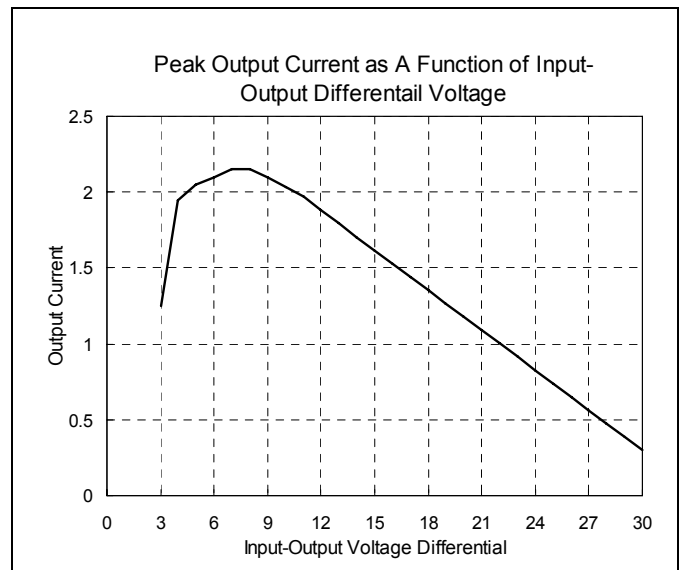
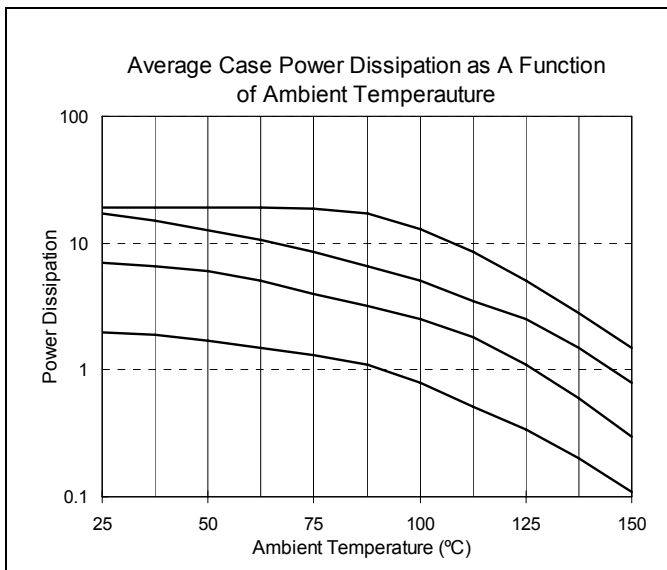
Ordering Information

Device	Package	Shipping
LM7912E3-B-UB-X	TO-220 (Pb-free lead plating package)	50 pcs/tube, 20 tubes/box, 4 boxes / carton





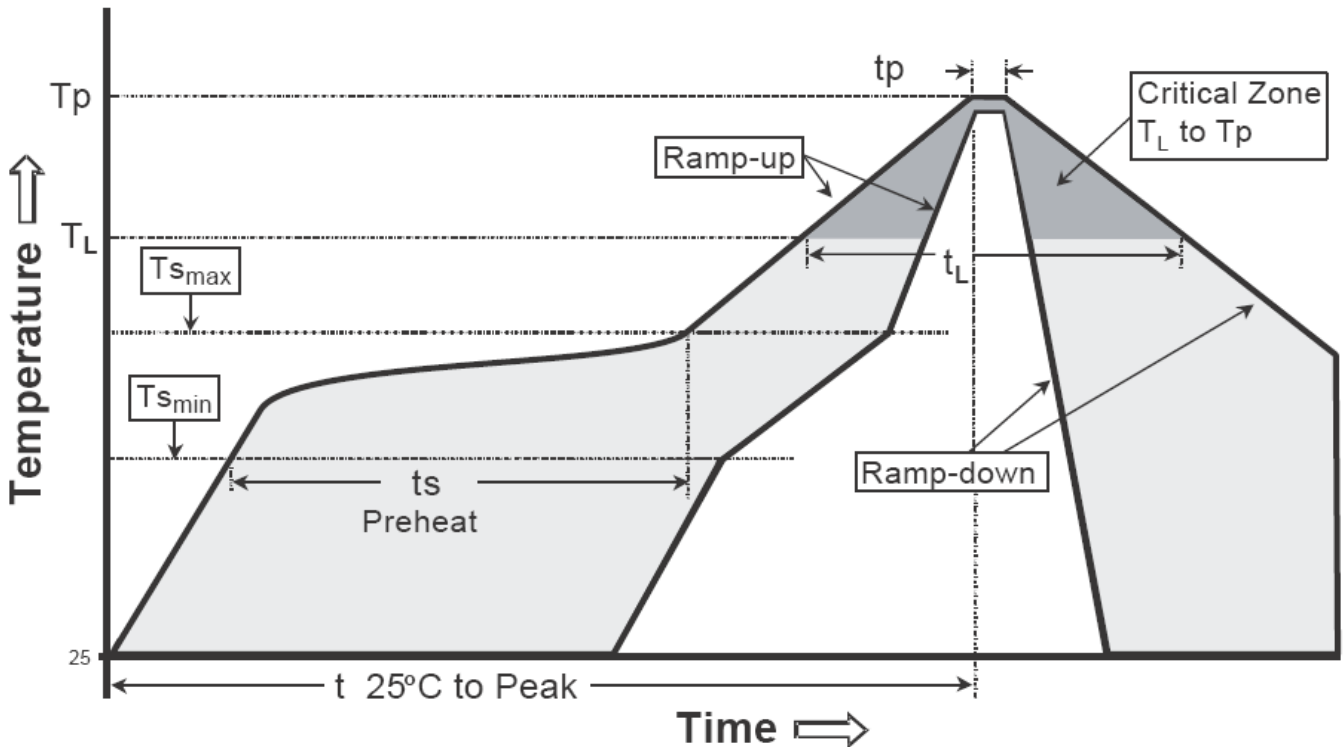
Typical Characteristics



Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

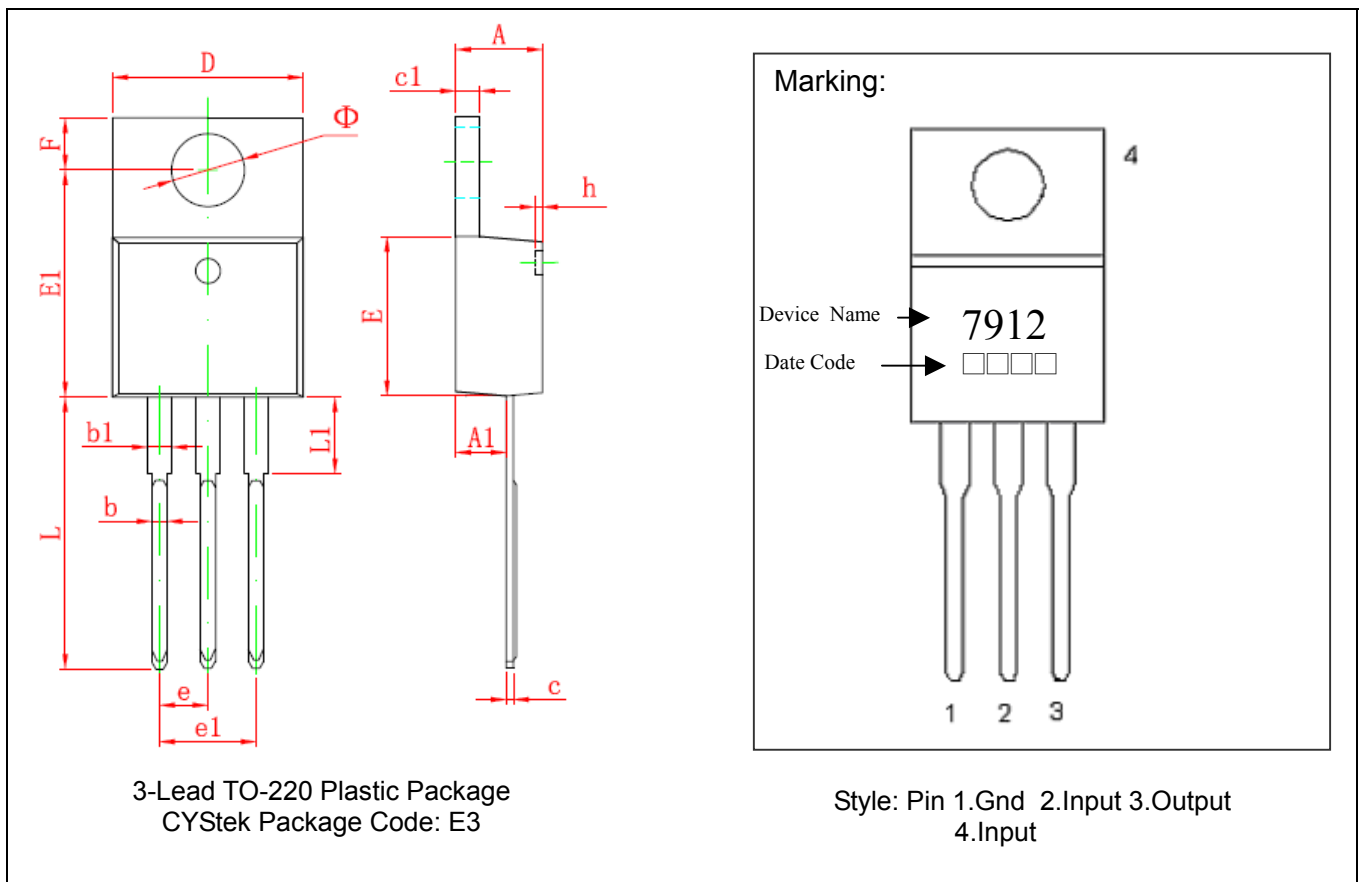
Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.	3°C/second max.
Preheat		
-Temperature Min(T _{s min})	100°C	150°C
-Temperature Max(T _{s max})	150°C	200°C
-Time(t _{s min} to t _{s max})	60-120 seconds	60-180 seconds
Time maintained above:		
-Temperature (T _L)	183°C	217°C
- Time (t _L)	60-150 seconds	60-150 seconds
Peak Temperature(T _P)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

TO-220 Dimension



*: Typical

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184	E1	12.060	12.460	0.475	0.491
A1	2.520	2.820	0.099	0.111	e	2.540*		0.100*	
b	0.710	0.910	0.028	0.036	e1	4.980	5.180	0.196	0.204
b1	1.170	1.370	0.046	0.054	F	2.590	2.890	0.102	0.114
c	0.310	0.530	0.012	0.021	h	0.000	0.300	0.000	0.012
c1	1.170	1.370	0.046	0.054	L	13.400	13.800	0.528	0.543
D	10.010	10.310	0.394	0.406	L1	3.560	3.960	0.140	0.156
E	8.500	8.900	0.335	0.350	Φ	3.735	3.935	0.147	0.155

Notes: 1.Controlling dimension: millimeters.
 2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.
 3.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead: Pure tin plated.
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0.

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